

Fig 5

40F7

actual

# Multi-Layer Thick Film Firing Profile

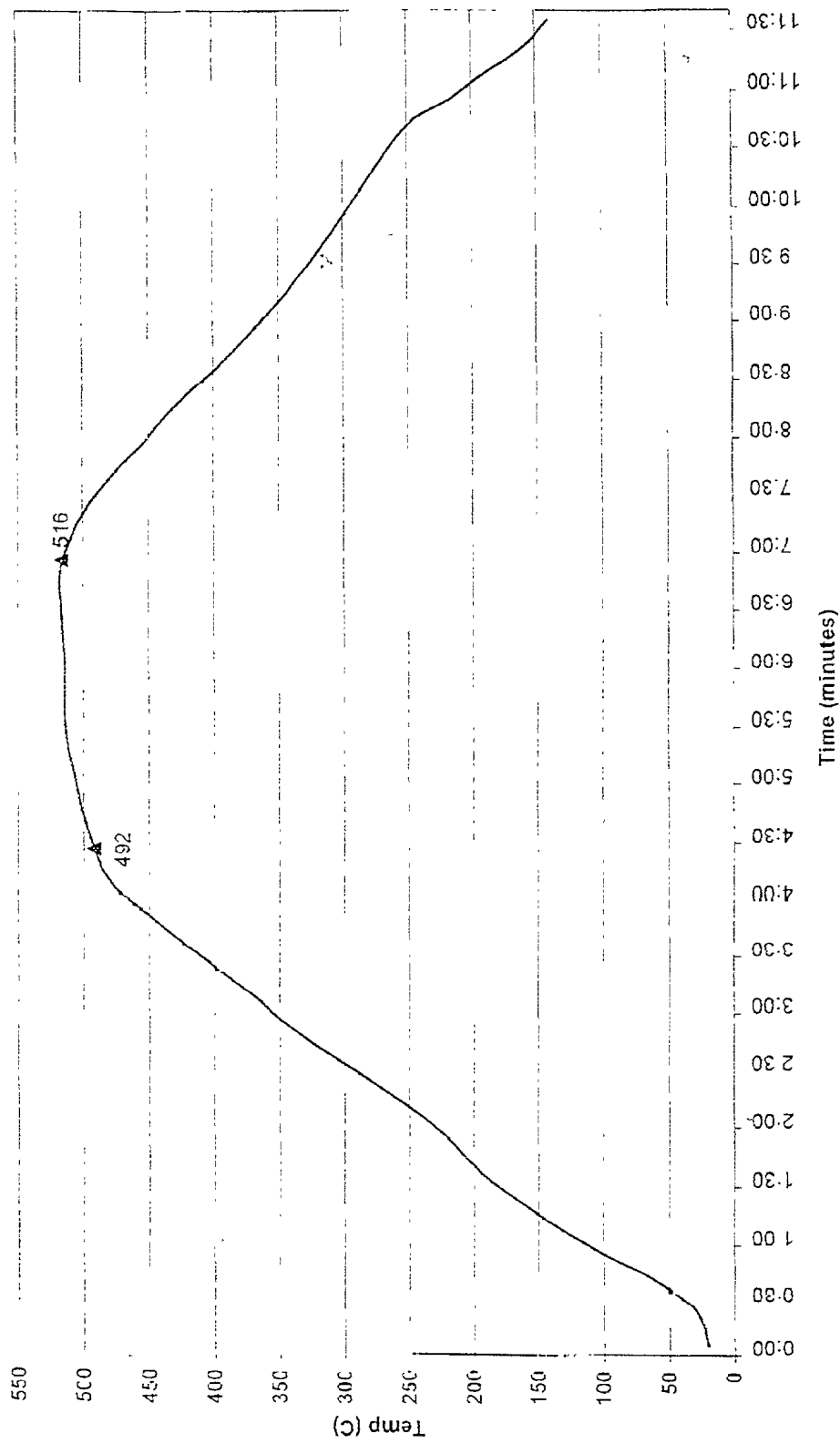


Fig 6

Prepared by Andrea Marble

12-1-00

MicroTouch Confidential

50F7

Apply Dielectric boarder layer to resistive surface (Screen printing) and dry <sup>100</sup> (Fig 3)

Apply wire traces on dielectric boarder layer and edge electrode pattern on resistive surface and dry (Screen Printing) <sup>102</sup> (Fig 4)

Fig 7

Apply Protective Boarder layer over edge electrode pattern and over wire traces and dielectric boarder <sup>104</sup> (Fig 5)

Fire (See Fig 6) <sup>106</sup>

Apply antimicrobial/antiscatter Coating and/or hardcoat (optional) <sup>108</sup>

attach wiring harness <sup>110</sup>

Fig 7

0077596:0004



70F7

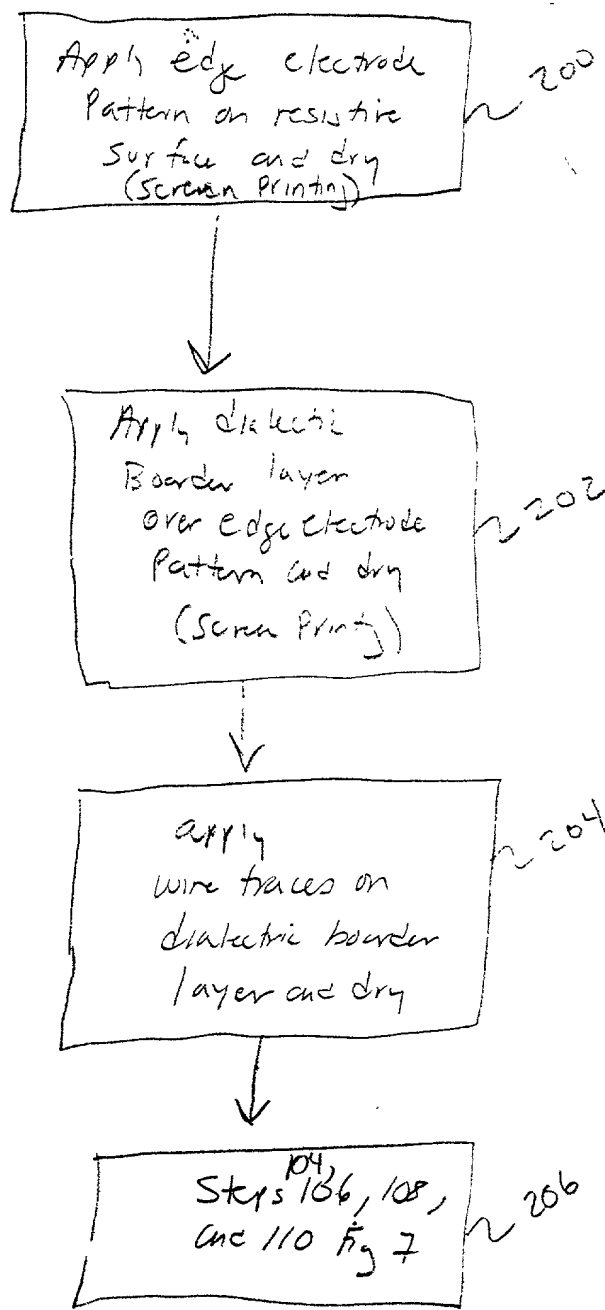


Fig 10